



Temperature protection device

## Chip NTC thermistor

Automotive grade: Corresponding to 125,150,175°C

# NTCG series

NTCG 0603 JIS 0603 [EIA 0201] NTCG 1005 JIS 1005 [EIA 0402] NTCG 1608 JIS 1608 [EIA 0603] NTCG 2012 JIS 2012 [EIA 0805]



## REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

## **SAFETY REMINDERS**

Please pay sufficient attention to the warnings for safe designing when using this products.

## **⚠** REMINDERS

Please pay careful attention to the precautions and follow safe designing practices when using these products. Incorrect usage may lead to destroyed NTC thermistors and damages or malfunctions with the devices used.

- OPlease use them within the ranges of the ratings and performance provided in the catalog and delivery specifications upon confirming the environments where they are to be used and installed.
- On Do not use them outside the operating temperature range.
- O Do not use them with the ratings or maximum permissible power levels exceeded.
- On not quickly apply 5mW or more of load with the constant-voltage power supply in the NTC thermistor as this may lead to staying in thermal runaway mode or the red-shorting of chips.
- Please be cautious of the applied voltage in thermistors as instruments may malfunction with the lowering of resistance due to self heating.
- O With instruments that consumers can touch the thermistors with their hands, please carefully warn them not to touch the thermistors.
- O Store them in locations where the temperature is 10°C to +40°C and the relative humidity is 75% or below, avoid environments where there are sudden changes in temperatures, direct sunlight, corrosive gas, grit, or dust, and keep them packed in a manner where no loading stress is applied in order to avoid deterioration and damage. (please use them within six months.)
- When sealing thermistors, please do so upon first considering the type, quantity, hardening conditions, and adhesiveness of the sealing material and confirming its reliability.
- Avoid powerful vibrations, impact (such as by dropping), pressure, etc. on thermistors that exceed the prescribed levels.
- On not use them for long periods of time in environments with a relative humidity of over 85%. (this excludes cases where countermeasures have been taken.)
- On ontruse them in the following environments. (this excludes cases where countermeasures have been taken.)
  - Corrosive gases (Cl2, NH3, SOx, NOx, etc.)
  - Environments with highly conductive substances (electrolytes, water, saltwater, etc.)
  - · Environments with acid, alkali, or organic solvents
  - · Dusty areas
- OPlease observe the following precautions when attaching them to substrates as failure to do so may result in destruction or malfunction.
  - $\boldsymbol{\cdot}$  Do not let the substrates get warped or twisted at any time during the soldering.
  - · The landing size must be even on both the left and right sides.
  - · Do not use items that have been dropped or detached.
  - · Do not allow the adherence of more solder than needed.
- Reflow mounting is recommended with NTC thermistors, and not flow (dip) mounting.
- Attaching or making corrections with a soldering iron is not recommended as it can lead to troubles such as significant distorting due to thermal shock or cracking. If a soldering iron must be used, it should be 30W or below with the temperature of the tip at 350°C or below, and at a maximum of 5 seconds of soldering time. Also, do not let the tip of the soldering iron come in direct contact with the chips.
- O Please use a substance such as resin that does not generate hydrogen (H2) when forming insulation film over chips.
- O Please contact our sales offices when considering the use of the products listed on this catalog for applications, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property ('specific uses' such as automobiles, airplanes,medical instruments, nuclear devices, etc.) as well as when considering the use for applications that exceed the range and conditions of this catalog.

Please note that we are not responsible for any damages or losses incurred resulting from the use of these products that exceeds the range and conditions of this catalog or specific uses.

Please take appropriate measures such as acquiring protective circuits and devices that meet the uses, applications, and conditions of the instruments and keeping backup circuits.



Automotive grade:Corresponding to 125,150,175°C

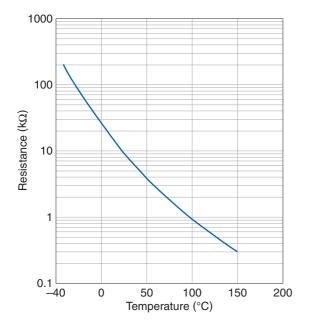
Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

## **Overview of the NTCG series**

### **CHARACTERISTICS OF NTC THERMISTORS**

NTC (Negative Temperature Coefficient) thermistors are manufactured from sintered metal oxides. Each thermistor consists of a combination of two to four of the following materials: manganese, nickel, cobalt and copper. NTC thermistors are semiconductor resistors that exhibit decreasing resistance characteristics with increasing temperature. TDK thermistors have low thermal time constants which result in extremely high rates of resistance change to accurately track the temperature.

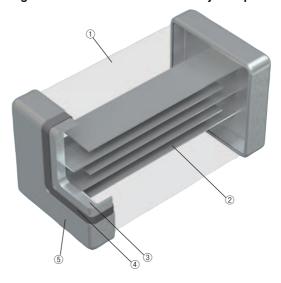
## Fig.1 R-T Curve : 10kohm@25°C



#### FEATURES OF NTCG SERIES

- 125°C compatible lineup
- 150°C compatible lineup
- 175°C compatible lineup (guaranteed separately)
- O AEC-Q200 compliant.

Fig.2 Internal structure of the multilayer chip Thermistors



No.	Name	
1	Semiconductor ceramics	
2	Internal electrode (Pd)	
3	Ag	
4	Terminal electrode Ni	
(5)	Sn	

RoHS Directive Compliant Product: See the following for more details.https://product.tdk.com/info/en/environment/rohs/index.html



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## **Overview of the NTCG series**

#### PART NUMBER CONSTRUCTION NTC G 3E Н 101 Nominal Nominal shapes and B constant Series Structural dimensions В resistance resistance Packaging tolerance **TDK** internal code name classification Code constant<sup>s</sup> tolerance style (%) (%)NTC 125°C vehicle response Multilayer 06 0603 F D ±0.5 ±1 300 30 Т Taping DS thermistor B constant: 25/85°C internal 125°C vehicle response electroded 1005 Н 101 В Bulk 10 ±3 100 DSX ±1 chip type NTC thermistor B constant: 25/50°C 1000 150°C vehicle response Н 16 1608 102 ±3 1S (Pb free type) $(1k\Omega)$ B constant: 25/85°C 10000 150°C vehicle response 20 2012 103 J ±5 1SX $(10k\Omega)$ B constant: 25/50°C 175°C vehicle response 1H B constant: 25/85°C 175°C vehicle response 1HX B constant: 25/50°C \* B constant B constant(K) 2000 to 2050 ЗА 3000 to 3050 4000 to 4050 4A 2A 2051 to 2100 3B 3051 to 3100 4B 4051 to 4100 2B

The B constant indicates the magnitude of a change in a zero-load resistance value to a temperature, and is obtained based on arbitrary two temperatures in resistance-to-temperature characteristics.

4101 to 4150

4201 to 4250

4251 to 4300

4401 to 4450

4451 to 4500

4501 to 4550

4601 to 4650

4701 to 4750

4801 to 4850

### B constant calculation formula

2101 to 2150

2201 to 2250

2251 to 2300

2401 to 2450

2451 to 2500

2501 to 2550

2601 to 2650

2701 to 2750

2801 to 2850

2C

2E

2F 2J

2K 2L

2N

2Q

3C

3E

3F

ЗJ

3K

3L

3N

30

3S

 $B = \frac{InR1 - InR2}{(1/T1) - (1/T2)}$ 

B: B constant (K)

T1:Arbitrary temperature (K)

3101 to 3150

3201 to 3250

3251 to 3300

3401 to 3450

3451 to 3500

3501 to 3550

3601 to 3650

3701 to 3750

3801 to 3850

T2:Arbitrary temperature different from T1 (K) R1:Zero-load resistance value at temperature T1( $\Omega$ )

R2:Zero-load resistance value at temperature  $T2(\Omega)$ 

4C

4E

4F

4J

4K

4L

4N

4Q

**4S** 

Each temperature is measured in absolute temperature. 0°C=273.15K

Dimensions in mm Shape symbol (JIS) 0603 0.60±0.03 0.30±0.03 0.30±0.03 0.1min 1005 1.00±0.05 0.50±0.05 0.50±0.05 0.1min 1608 1.60±0.10  $0.80\pm0.10$  $0.80\pm0.10$ 0.2min 2012 2.00±0.20 1.25±0.20 0.70±0.20 0.2min

## **Temperature Protection Devices**



## **NTC Thermistors**

Automotive grade:Corresponding to 125,150,175°C

Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

## **Overview of the NTCG series**

## ■ RATINGS 125°C RESPONSE COUNTERPARTS

Size	mm	0603	1005	1608	2012
Maximum rated power (25°C)Asteris*1	mW	100	100	100	200
Dissipation factors (25°C) *2	mW/°C   mW/K	1	1	1	2

### ■ RATINGS 150°C RESPONSE COUNTERPARTS

Size	mm	1005	1608	2012
Maximum rated power (25°C)Asteris*1	mW	125	125	250
Dissipation factors (25°C) *2	mW/°C   mW/K	1	1	2

### ■ RATINGS 175°C RESPONSE COUNTERPARTS

Size	mm	1005	1608
Maximum rated power (25°C)Asteris*1	mW	150	150
Dissipation factors (25°C) *2	mW/°C   mW/K	1	1

<sup>\*1</sup> Maximum rated power: Maximum power: at rated temperature (25°C), maximum power that can be applied continuously

<sup>\*2</sup> Dissipation factors: powered that it is equivalent that be increased in self-heating by load power thermistor at 1°C temperature

## **Temperature Protection Devices**



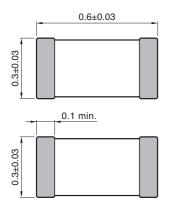
## **NTC Thermistors**

Automotive grade:Corresponding to 125,150,175°C

Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

## NTCG series 0603 type

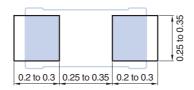
### **SHAPE & DIMENSIONS**



Electrode material Internal:Pd External:Ag/Ni/Sn

Dimensions in mm

### ■ RECOMMENDED LAND PATTERN





## ■125°C RESPONSE COUNTERPARTS (OPERATING TEMPERATURE RANGE: -40 to 125°C)

Part No.	Resistance [25°C] (Ω)	Resistance tolerance	B constant [25/50°C] (K)	B constant [25/75°C] (K)	B constant [25/85°C] (K)	B constant [25/100°C] (K)	B constant tolerance	Permissible operating current [25°C] (mA)
NTCG063JF103FTDS	10,000	±1%	3380	3422	3435	3453	±1%	0.31
NTCG064EF104FTDSX	100,000	±1%	4250	4293	4308	4327	±1%	0.10

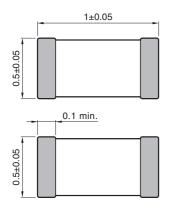


Automotive grade:Corresponding to 125,150,175°C

Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

## NTCG series 1005 type

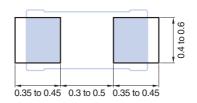
### **SHAPE & DIMENSIONS**



Electrode material Internal:Pd External:Ag/Ni/Sn

Dimensions in mm

#### ■ RECOMMENDED LAND PATTERN





## ■125°C RESPONSE COUNTERPARTS (OPERATING TEMPERATURE RANGE: -40 to 125°C)

Part No.	Resistance [25°C]	Resistance tolerance	B constant [25/50°C]	B constant [25/75°C]	B constant [25/85°C]	B constant [25/100°C]	B constant tolerance	Permissible operating current [25°C]
	<b>(</b> Ω <b>)</b>		(K)	(K)	(K)	(K)		(mA)
NTCG103JF103JTDS	10,000	±5%	3380	3422	3435	3453	±1%	0.31
NTCG103JF103HTDS	10,000	±3%	3380	3422	3435	3453	±1%	0.31
NTCG103JF103FTDS	10,000	±1%	3380	3422	3435	3453	±1%	0.31
NTCG103JX103DTDS	10,000	±0.5%	3380	3422	3435	3453	±0.7%	0.31
NTCG104LH223JTDS	22,000	±5%	4485	4533	4550	4573	±3%	0.21
NTCG104LH473JTDS	47,000	±5%	4485	4533	4550	4573	±3%	0.14
NTCG104BF473JTDSX	47,000	±5%	4050	4098	4114	4137	±1%	0.14
NTCG104BF473HTDSX	47,000	±3%	4050	4098	4114	4137	±1%	0.14
NTCG104BF473FTDSX	47,000	±1%	4050	4098	4114	4137	±1%	0.14
NTCG104BF683FTDSX	68,000	±1%	4085	4134	4150	4172	±1%	0.12
NTCG104LH104JTDS	100,000	±5%	4485	4533	4550	4573	±3%	0.10
NTCG104EF104HTDSX	100,000	±3%	4250	4293	4308	4327	±1%	0.10
NTCG104EF104FTDSX	100,000	±1%	4250	4293	4308	4327	±1%	0.10
NTCG104ED104DTDSX	100,000	±0.5%	4250	4293	4308	4327	±0.5%	0.10
NTCG104LH154JTDS	150,000	±5%	4485	4533	4550	4573	±3%	0.05

## ■150°C RESPONSE COUNTERPARTS (OPERATING TEMPERATURE RANGE: -40 to 150°C)

Part No.	Resistance [25°C] (Ω)	Resistance tolerance	B constant [25/50°C] (K)	B constant [25/75°C] (K)	B constant [25/85°C] (K)	B constant [25/100°C] (K)	B constant tolerance	Permissible operating current [25°C] (mA)
NTCG103JF103JT1S	10,000	±5%	3380	3422	3435	3453	±1%	0.31
NTCG103JF103HT1S	10,000	±3%	3380	3422	3435	3453	±1%	0.31
NTCG103JF103FT1S	10,000	±1%	3380	3422	3435	3453	±1%	0.31
NTCG103JX103DT1S	10,000	±0.5%	3380	3422	3435	3453	±0.7%	0.31
NTCG104LH473JT1S	47,000	±5%	4485	4533	4550	4573	±3%	0.14
NTCG104BF473JT1SX	47,000	±5%	4050	4098	4114	4137	±1%	0.14
NTCG104BF473HT1SX	47,000	±3%	4050	4098	4114	4137	±1%	0.14
NTCG104BF473FT1SX	47,000	±1%	4050	4098	4114	4137	±1%	0.14
NTCG104LH104JT1S	100,000	±5%	4485	4533	4550	4573	±3%	0.10
NTCG104EF104HT1SX	100,000	±3%	4250	4293	4308	4327	±1%	0.10
NTCG104EF104FT1SX	100,000	±1%	4250	4293	4308	4327	±1%	0.10
NTCG104ED104DT1SX	100,000	±0.5%	4250	4293	4308	4327	±0.5%	0.10

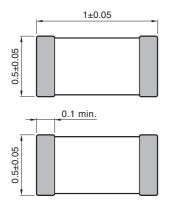


Automotive grade:Corresponding to 125,150,175°C

Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

## NTCG series 1005 type

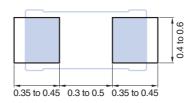
### **SHAPE & DIMENSIONS**



Electrode material Internal:Pd External:Ag/Ni/Sn

Dimensions in mm

#### ■ RECOMMENDED LAND PATTERN





## ■175°C RESPONSE COUNTERPARTS (OPERATING TEMPERATURE RANGE: -40 to 175°C)

Part No.	Resistance [25°C] (Ω)	Resistance tolerance		B constant [25/75°C] (K)			B constant tolerance	Permissible operating current [25°C] (mA)
NTCG103JF103FT1H	10,000	±1%	3380	3422	3435	3453	±1%	0.31
NTCG104KF104FT1H	100,000	±1%	4419	4468	4485	4509	±1%	0.10

<sup>\*</sup> Solder joint is not guaranteed. It is guaranteed as a single part.

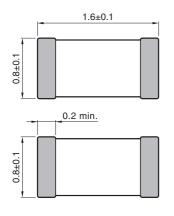


Automotive grade:Corresponding to 125,150,175°C

Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

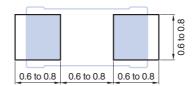
## NTCG series 1608 type

### **SHAPE & DIMENSIONS**



Electrode material Internal:Pd External:Ag/Ni/Sn

### ■ RECOMMENDED LAND PATTERN



Dimensions in mm



## ■125°C RESPONSE COUNTERPARTS (OPERATING TEMPERATURE RANGE: -40 to 125°C)

Part No.	Resistance	Resistance	B constant	Permissible operating current				
	[25°C]	tolerance	[25/50°C]	[25/75°C]	[25/85°C]	[25/100°C]	tolerance	[25°C]
	<b>(</b> Ω <b>)</b>		(K)	(K)	(K)	(K)		(mA)
NTCG163EH101HTDS	100	±3%	3244	3249	3250	3251	±3%	3.16
NTCG164BH222JTDS	2,200	±5%	4096	4100	4100	4100	±3%	0.67
NTCG164BH472JTDS	4,700	±5%	4067	4092	4100	4110	±3%	0.46
NTCG163JF103HTDS	10,000	±3%	3380	3422	3435	3453	±1%	0.31
NTCG163JF103FTDS	10,000	±1%	3380	3422	3435	3453	±1%	0.31
NTCG163JX103DTDS	10,000	±0.5%	3380	3422	3435	3453	±0.7%	0.31
NTCG164BH103JTDS	10,000	±5%	4067	4092	4100	4110	±3%	0.31
NTCG164LH223JTDS	22,000	±5%	4485	4533	4550	4573	±3%	0.21
NTCG164LH473JTDS	47,000	±5%	4485	4533	4550	4573	±3%	0.14
NTCG164LH473HTDS	47,000	±3%	4485	4533	4550	4573	±3%	0.14
NTCG164BF473FTDSX	47,000	±1%	4050	4098	4114	4137	±3%	0.14
NTCG164LH104JTDS	100,000	±5%	4485	4533	4550	4573	±3%	0.10
NTCG164LH104HTDS	100,000	±3%	4485	4533	4550	4573	±3%	0.10
NTCG164KF104FTDS	100,000	±1%	4419	4468	4485	4509	±1%	0.10
NTCG164LH154JTDS	150,000	±5%	4485	4533	4550	4573	±3%	0.08
NTCG164QF474JTDS	470,000	±5%	4632	4698	4720	4749	±1%	0.04
NTCG164QF474HTDS	470,000	±3%	4632	4698	4720	4749	±1%	0.04

## ■150°C RESPONSE COUNTERPARTS (OPERATING TEMPERATURE RANGE: -40 to 150°C)

Part No.	Resistance [25°C] (Ω)	Resistance tolerance	B constant [25/50°C] (K)	B constant [25/75°C] (K)	B constant [25/85°C] (K)	B constant [25/100°C] (K)	B constant tolerance	Permissible operating current [25°C] (mA)
NTCG163JF103HT1S	10,000	±3%	3380	3422	3435	3453	±1%	0.31
NTCG163JF103FT1S	10,000	±1%	3380	3422	3435	3453	±1%	0.31
NTCG163JX103DT1S	10,000	±0.5%	3380	3422	3435	3453	±0.7%	0.31
NTCG164LH473JT1S	47,000	±5%	4485	4533	4550	4573	±3%	0.14
NTCG164LH473HT1S	47,000	±3%	4485	4533	4550	4573	±3%	0.14
NTCG164BF473FT1SX	47,000	±1%	4050	4098	4114	4137	±3%	0.14
NTCG164LH104JT1S	100,000	±5%	4485	4533	4550	4573	±3%	0.10
NTCG164LH104HT1S	100,000	±3%	4485	4533	4550	4573	±3%	0.10
NTCG164KF104FT1S	100,000	±1%	4419	4468	4485	4509	±1%	0.10
NTCG164QF474JT1S	470,000	±5%	4632	4698	4720	4749	±1%	0.04
NTCG164QF474HT1S	470,000	±3%	4632	4698	4720	4749	±1%	0.04

A Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

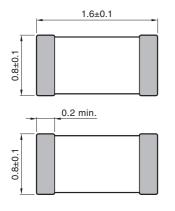


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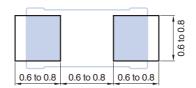
## NTCG series 1608 type

### **SHAPE & DIMENSIONS**



Electrode material Internal:Pd External:Ag/Ni/Sn

### ■ RECOMMENDED LAND PATTERN



Dimensions in mm



## ■175°C°C RESPONSE COUNTERPARTS (OPERATING TEMPERATURE RANGE: -40 to 175°C)

Part No.	Resistance	Resistance	B constant	Permissible operating current				
	[25°C]	tolerance	[25/50°C]	[25/75°C]	[25/85°C]	[25/100°C]	tolerance	[25°C]
	<b>(</b> Ω <b>)</b>		(K)	(K)	(K)	(K)		(mA)
NTCG163JF103FT1H	10,000	±1%	3380	3422	3435	3453	±1%	0.31
NTCG164KF104FT1H	100,000	±1%	4419	4468	4485	4509	±1%	0.10

\* Solder joint is not guaranteed. It is guaranteed as a single part.

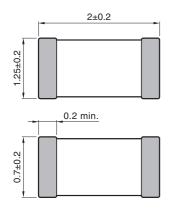


Automotive grade:Corresponding to 125,150,175°C

Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

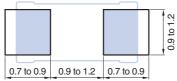
## NTCG series 2012 type

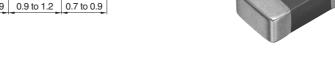
### **SHAPE & DIMENSIONS**



Electrode material Internal:Pd External:Ag/Ni/Sn

### ■ RECOMMENDED LAND PATTERN





Dimensions in mm

### ■125°C RESPONSE COUNTERPARTS (OPERATING TEMPERATURE RANGE: -40 to 125°C)

Part No.	Resistance	Resistance	B constant	Permissible operating current				
	[25°C]	tolerance	[25/50°C]	[25/75°C]	[25/85°C]	[25/100°C]	tolerance	[25°C]
	<b>(</b> Ω <b>)</b>		(K)	(K)	(K)	(K)		(mA)
NTCG203NH103JTDS	10,000	±5%	3590	3635	3650	3670	±3%	0.44
NTCG204AH473JTDS	47,000	±5%	3930	3982	4000	4032	±3%	0.20
NTCG204CH104JTDS	100,000	±5%	4085	4134	4150	4172	±3%	0.14

## ■150°C RESPONSE COUNTERPARTS (OPERATING TEMPERATURE RANGE: -40 to 150°C)

Part No.								Permissible operating current
	[25°C] (Ω)	tolerance	[25/50°C] (K)	[25/75°C] (K)	[25/85°C] (K)	[25/100°C] (K)	tolerance	[25°C] (mA)
NTCG203NH103JT1S	10,000	±5%	3590	3635	3650	3670	±3%	0.44
NTCG204AH473JT1S	47,000	±5%	3930	3982	4000	4032	±3%	0.20
NTCG204CH104JT1S	100,000	±5%	4085	4134	4150	4172	±3%	0.14



Automotive grade: Corresponding to 125,150,175°C

Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

## NTCG series RT table

### R-T TABLE ACQUISITION PROCEDURE

- 1. Access the top page of the TDK chip NTC thermistor (protective device) https://product.tdk.com/info/en/products/protection/temperature/chip-ntc-thermistor/index.html
- 2. Click [Search by Part No.] https://product.tdk.com/en/search/protection/temperature/chip-ntc-thermistor/part\_no/
- 3. Enter the product name you want in the RT table in the box and click the Search button. (Example: NTCG103JF103FT1)



#### Wildcard and Multiple Part number.

- Question mark (?) and asterisk (\*) can be used as wildcard characters.
   The question mark (?) matches any single character, and the asterisk (\*) matches any sequence of characters.
- Enter only one part number per line. Up to 50 part numbers can be searched simultaneously.
- A part number search is normally performed using a prefix search. If you
  wish to use a suffix search, enter an exclamation mark (!) at the end of
  the Part No.

Click the displayed product name.
 (Example: NTCG103JF103FT1)



5. Individual pages are displayed and click the RT table in the "Document" on the right side bar.



6. You can download the csv file in the 1°C step of the RT table for the product.



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## Attention in the board design

#### **BOARD DESIGN**

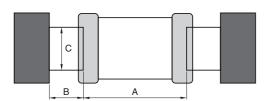
When attached to NTC substrate thermistor, amount of silver used (fillet size) has direct impact on NTC thermistor after mounting. Thus, sufficient consideration is necessary.

#### Set of land dimensions

(1) As the stress rises in the NTC thermistor owing to the increase in silver, breakage and cracks will occur. Cause including crack, as caution on board land design, configure the shape and dimensions so that the amount of silver is appropriate.

If you installed 2 or more parts in the Common Land, separated by a solder resist and special land of each component.

Dimensions shape



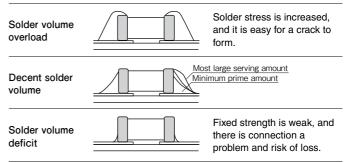
Shape symbol	Symbol				
Shape Symbol	A	В	С		
0603	0.25 to 0.35	0.20 to 0.30	0.25 to 0.35		
1005	0.30 to 0.50	0.35 to 0.45	0.40 to 0.60		
1608	0.60 to 0.80	0.60 to 0.80	0.60 to 0.80		
2012	0.90 to 1.20	0.70 to 0.90	0.90 to 1.20		

(2) When peak levels panning-at soldering is excessive, by solder contraction stress, mechanical-thermal stress causes a Yasuku chip crack.

In addition, when the peak level is underestimated, terminal electrode fixed strength is insufficient. This causes chip dropouts and may affect circuit reliability.

Representative example of the panning of peak levels is shown in the following.

#### Recommended silver dose



## Case and suggested protocol want to avoid

Example	Cases to avoid	Improvement example (land division)
Lead wire and land of part discrete doubles up	Leads Chip Solder	Solder resist Leads
Arrangements in the vicinity	Chassis Solder (ground solder)	Solder resist  L2  L2>L1
Arrangements of chip component's companion	Excess solder  Land  Missing solder	Solder resist



Automotive grade:Corresponding to 125,150,175°C

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## Attention in the board design

location away places the

perforation and slit.

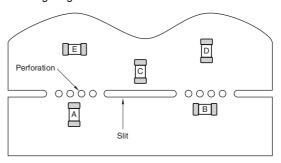
### **Arrangements of components**

(1) I was based on camber of substrate and suggested protocol of NTC thermistor arrangement, as stress does not join to the utmost is shown in following.

Substrate for flexural stress Substrate for flexural stress Adverse events Good example Perforation or slit Perforation or slit Direction of surface solder Solder the mountain fold as a Solder the mountain fold as a Perforation or slit Perforation or slit Chip arrangements (direction) Mounted vertically to the Mounted horizontally to the perforation and slit. perforation and slit. Distance from perforation and 📕 slit portion (L1<L2) Close location is It is an advantage so distant

disadvantageous of perforation and slit.

(2) In payment near by board, depending on mount position of NTC PTC, as mechanical stress varies, please refer to the following diagram.



The order of A > B = C > D > E eases the stress.



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## Attention on the mounting

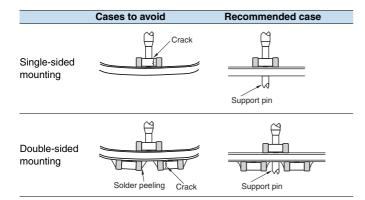
### **APPLICATION TO BOARD**

#### Mounting head pressure

Under suction nozzle if dead point too, during implementation, excessive force joins of NTC thermistor low, as cause causes of crack, please use with reference to something about following.

- Being set to top surface of substrate so that under suction nozzle as for dead center, substrate does not bend back, and adjust, please.
- 2) Nozzle pressure at implementation is 1N 3N in static load, please.
- Substrate fixes up back surface of substrate with support pin in impact of suction nozzle to wely deflection to the utmost, and substrate hold deflection, please.

A representative example is shown in the following.



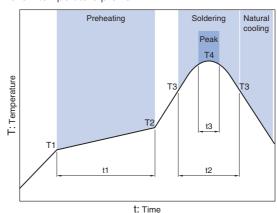
Mechanical shock that, if positioning your nail to wear, ragged edge of positionings, participates in NTC thermistor are locally, and NTC thermistor, as there is possibility of crack generated, cut the closed positioning, and maintenance and inspection, and, exchange of manage dimensions and position nail periodically, please.

## **SOLDERING**

Significant impact is possible on the performance of NTC thermistor, flux checks something about follow, please use.

- (1) Flux uses one with 0.1wt % (Cl conversion) or less halide substance contains amounts, please. In addition, do not do this with strongly acidic objects.
- (2) Flux during is soldered (2) NTC substrate thermistor is applied the smalleset amount necessary, please.
- (3) If Used soluble flux, perform thorough wash particularly, please.

Reflow temperature profile



	Specification			
Item	for eutectic mixture solder	For lead-free solder		
Preheating temperature	160 to 180°C	150 to 180°C		
Solder melting temperature	200°C	230°C		
Maximum temperature	240°C max.	260°C max.		
Preheating time	100s max.	120s max.		
Time to reach higher than the solder melting temperature	30s max.	40s max.		
number of possible reflow cycles	2 max.	2 max.		

### **SOLDERING IRON**

(1) The tip temperature and also by (1) types of soldering irons, the size of the substrate, and the geometry of the land pattern. Being earlier, but when as there is possibility that crack occurs in the heat anderson impaction, point soldering iron temperature is high, please do solder work within the following conditions.

Temperature of iron tips (°C)	Wattage (W)	Pallet point shape (mm)	Soldering time (Second)	Frequency
350max.	20max.	ø3.0max.	5 max.	Within each terminal once (Within total of twice)

(2) Direct iron tip is in contact with the (2) NTC thermistor body, and the strain owing to thermal shock in particular grows even if a crack is generated. Therefore, please do not touch it directly to the terminal electrodes.

## **ATDK**

## **NTC Thermistors**

Automotive grade: Corresponding to 125,150,175°C

Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

## Attention after mounting

### **CLEANING**

- (1) If cleaning liquid is inappropriate, residues and other foreign body of fluxes builds up on NTC PTC surface, and can degrade the performance of NTC thermistor (particularly the insulation resistance)
- (2) Wash conditions may compromise performance of NTC thermistor if they are improper (wash due, wash excess).

#### 2-1) For wash due

- (a) By substance of a system in flux residue halide, metal including terminal electrodes may experience corrosion.
- (b)Substance of a system in flux residue halide builds up on NTC PTC surface, and reduces the insulation resistance.
- (c) Soluble flux makes comparisons of colophony series flux, and there is event with trends of significant (1) and(2).

#### 2-2) For excess wash

- (1) Owing to lavage, NTC PTC surface deteriorates, and reduces performance of NTC thermistor.
- (2) In ultrasonography, when output is passed, substrate resonates size, and crack occurs in body and sprang of NTC thermistor in vibration of substrate. Since this may reduce the strength of the terminal electrode, please note the following conditions.

Output Ultrasound output

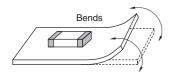
Frequency Ultrasonic frequency

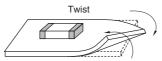
Cleaning time Ultrasound cleaning time

2-3) Concentration including halogen that when cleaning liquid to pollution, when you released is higher, and may cause similar of results into wash due.

## SUBSTRATE HANDLING AFTER COMPONENT MOUNTING

(1) When substrate is divided, a flexible so that show in following diagram to substrate, and is given by stress including twist, as there is possibility that crack occurs of NTC thermistor, please check that stress is within acceptable limits.



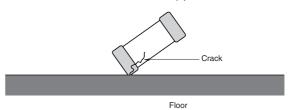


(2) During each substrate operational check, push pressure with contact failure of check pin of boards checkers of check pin may be toned up to be prevented. As substrate is bent under loading, NTC thermistor is broken owing to stress. There is also the possibility that solder on the terminal electrode will peel off. Follow the diagram for reference, and check that the substrate bends, please.

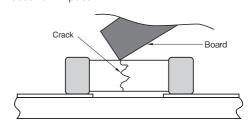
Item	Cases to avoid	Recommended case
Substrate sags	Peeling  Check pin	Support pin Check pin

#### SINGLE-PART COMPONENT HANDLING

(1) To drop impact, as there is possibility that breakage and crack is entered, do not NTC thermistor that(1) NTC thermistor falls.



(2) At stacking storage after implementation and treatment of substrate, corner of boards is regarded as NTC thermistor. Please be careful, as there is the possibility that breakage and cracks will occur on impact.



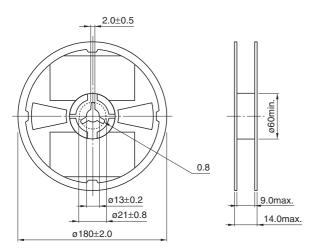


Automotive grade:Corresponding to 125,150,175°C

Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

## Packaging style

### ■ REEL DIMENSIONS

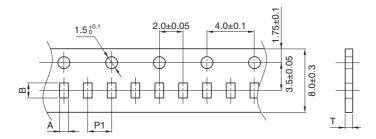


Dimensions in mm

## **■PACKAGE QUANTITY, PRODUCT WEIGHT**

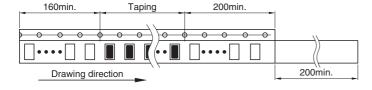
Туре	Package quantity (pieces/reel)	Individual weight (mg)
NTCG06	15,000	0.3
NTCG10	10,000	1.3
NTCG16	4,000	5.0
NTCG20	2,000	7.2

## **TAPE DIMENSIONS**



Dimensions in mm

Type	Α	В	P1	Т
0603	0.38±0.05	0.68±0.05	2±0.05	0.45max.
1005	0.65+0.05/-0.1	1.15+0.05/-0.1	2±0.05	0.65max.
1608	1.1±0.2	1.9±0.2	4.0±0.1	1.1max.
2012	1.6±0.2	2.3±0.2	4.0±0.1	1.1max.



Dimensions in mm



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## **Description and definition of terms**

#### **INITIAL RESISTANCE**

Thermistor resistance is a function of absolute temperature as indicated by the following relationship:

$$R=R_0 \bullet \exp B\left(\frac{1}{T}-\frac{1}{T_0}\right)....(1)$$

Here  $R_0$ ,  $R(k\Omega)$  are the respective resistance values when the surrounding temperature is  $T_0$ , T(K). B is the thermistor constant(B constant below).

#### **B CONSTANT**

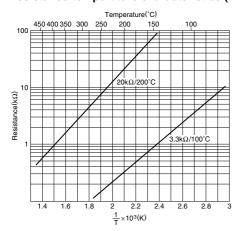
The B constant is found from the following equation:

$$B = \frac{2.3026(logR - logR_0)}{\frac{1}{T} - \frac{1}{T_0}}$$
 (2)

This B characteristic is indicated by the slope of the linear plot of log R-1/T inverse absolute temperature.

The B constant value is generally in the vicinity of 2500K to 5000K. B constant values of 3000K to 4000K are frequently used for measurements

#### Resistance-temperature characteristics (Fig.1)



### **TEMPERATURE COEFFICIENT**

The relationship between temperature coefficient  $\alpha$  and B becomes:

$$\alpha = \frac{1}{R} \cdot \frac{dR}{dT} = -\frac{B}{T^2} \times 100(\%)^{\circ}C)$$
 (3)

The negative sign of the temperature coefficient indicates that the temperature coefficient decreases as both thermistor resistance and temperature rise. If B is taken as 3400K, the temperature coefficient found at 20°C (293.15K) becomes –4%/°C.

## **Temperature Protection Devices**



#### ■ HEAT DISSIPATION COEFFICIENT

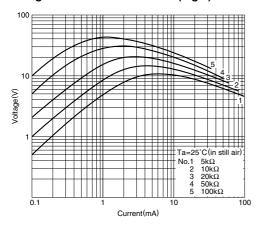
Temperature rises due to thermal energy formed as electrical current flows through the thermistor. The thermistor temperature  $T_0$  is then related to the surrounding temperature  $T_0$  and the electrical input W:

This k value is the heat dissipation coefficient, which represents the additional electrical power (mW/°C) needed to raise the thermistor temperature by 1°C. This heat dissipation coefficient varies with changes in the measurement and environmental conditions. When a thermistor is used for temperature measurement, it is naturally important to lower the applied electrical current as much as possible in order to reduce measurement error resulting from self heating.

### ■ VOLTAGE - CURRENT CHARACTERISTIC

The voltage - current characteristic indicates the drop in voltage as electrical current through the thermistor is gradually increased.

#### Voltage-current characteristics (Fig.2)



#### ■ HEATING TIME CONSTANT

The time period required to heat up a thermistor from a certain temperature  $T_0$  over a target temperature rise is called the heating time constant. Various types of heating time constants are indicated by the symbols shown in Table 1 as determined by the percent change from  $T_0$  toward the target temperature. The standard change is typically taken to be 63.2%.

## Thermal time constants (Fig.3)

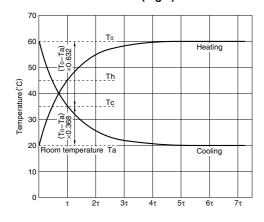


Table 1 Heating time constant and temperature change ratio

Code	Rate of change (%) for To -Ta
τ	63.2
2τ	86.5
3τ	95.0
4τ	98.2
5τ	99.4
6τ	99.8
7τ	99.9

#### ■ PERMISSIBLE OPERATING CURRENT

This is the maximum load current limit below 1°C temperature rise due to thermistor self-heating. It's possible to express it in the following system.

 $\mbox{Maximum allowed current } \mbox{[mA]} = \sqrt{ \mbox{ (Heat dissipation constant} \mbox{[mW/}^{\circ}\mbox{C}] \div \mbox{Resistance} \mbox{[k}\Omega]} \label{eq:maximum}$